

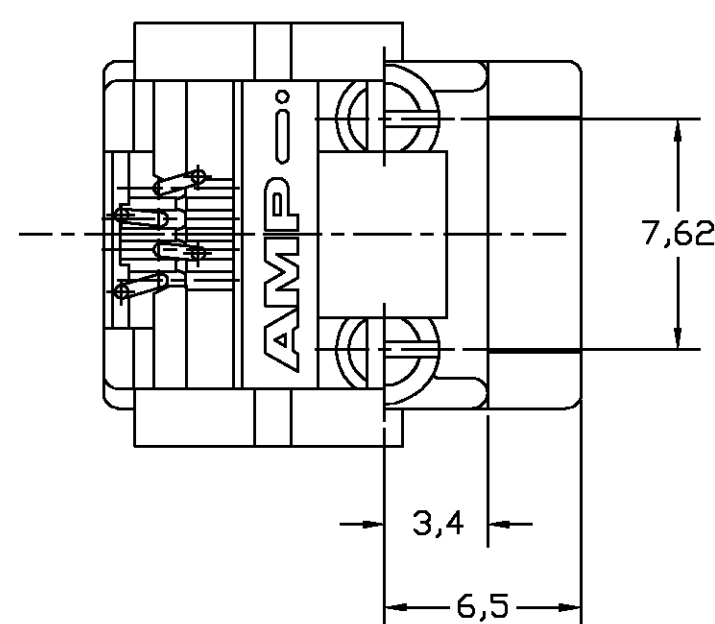
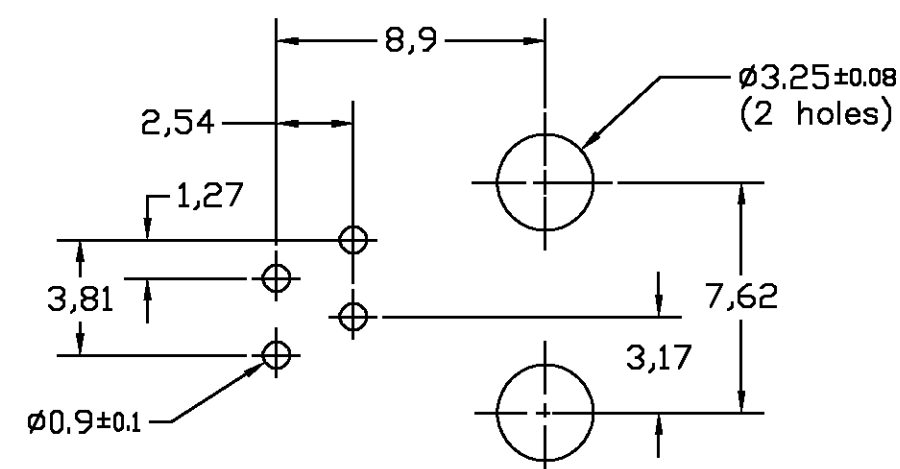
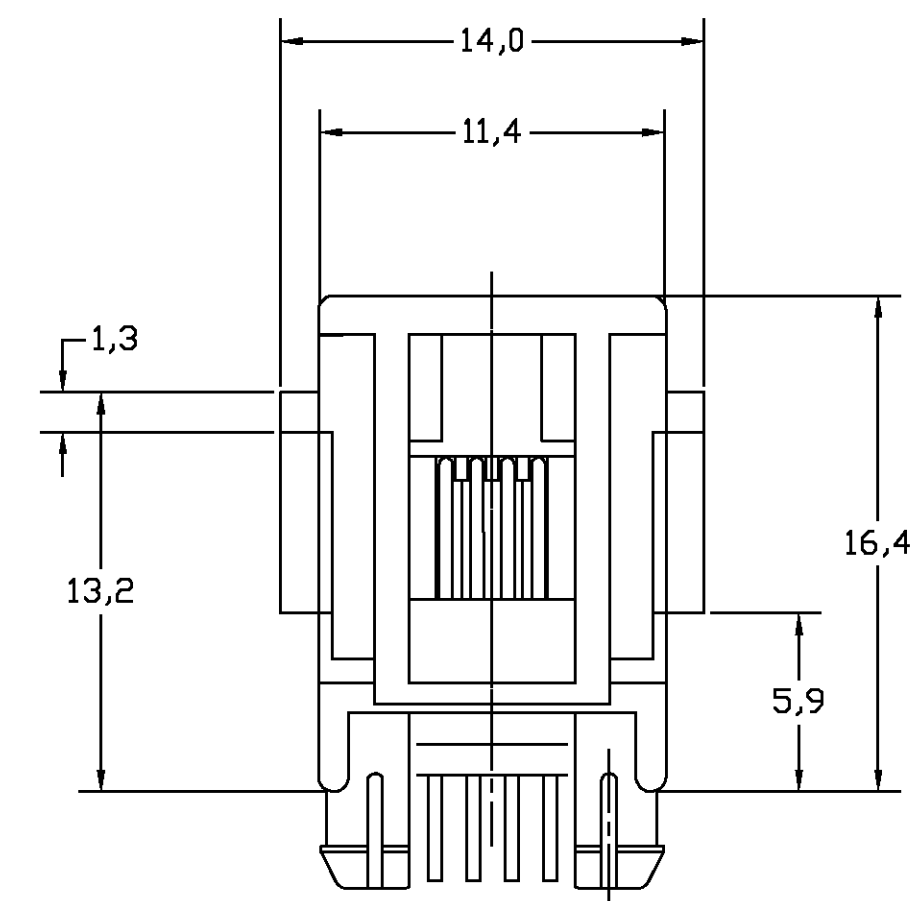
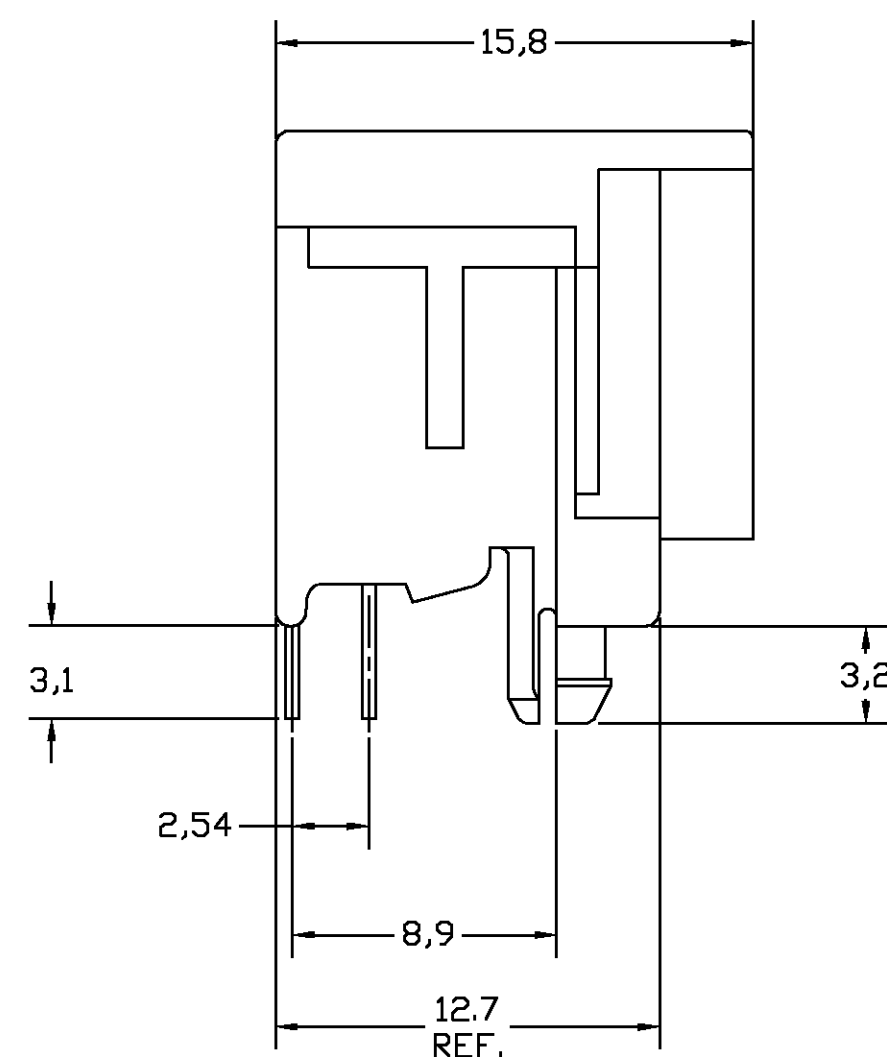
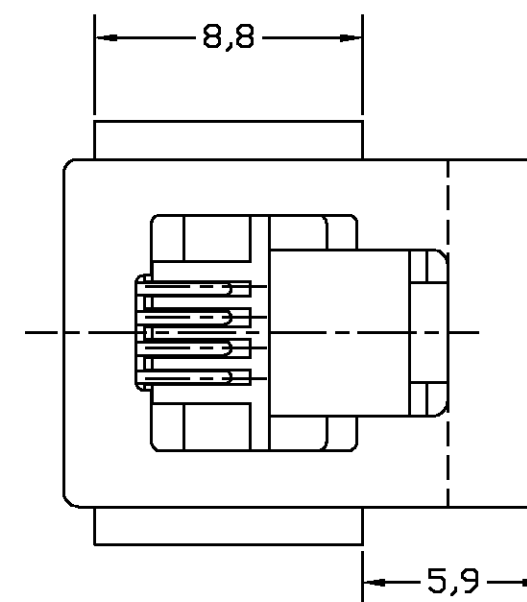
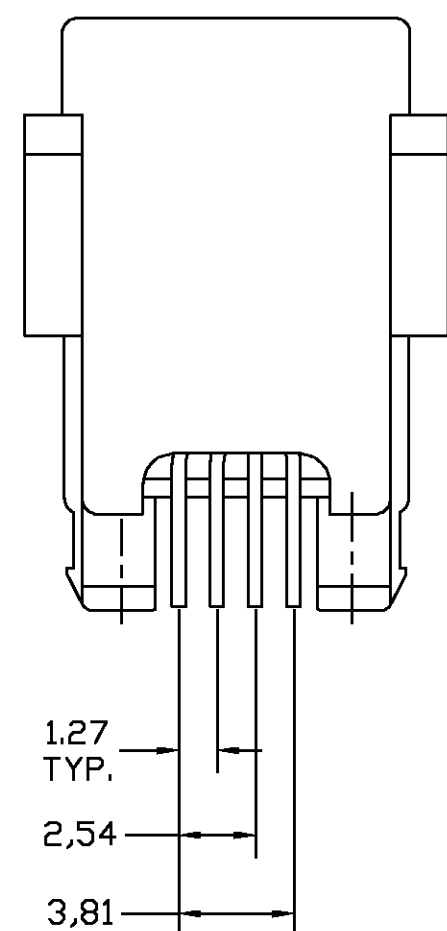
DO NOT SCALE
DIMENSIONS IN mm

METRIC



NOTES:

- 1 TOLERANCES UNLESS OTHERWISE SPECIFIED: $\pm 0,15$
- 2 FOR APPLICATION INFORMATION SEE AMP SPEC. 114-19019.
- 3 FOR PERFORMANCE REQUIREMENTS SEE AMP SPEC. 108-19064



PRINTED CIRCUIT BOARD LAYOUT

VIEW SHOWN IS CIRCUIT (NONCOMPONENT) SIDE OF BOARD.
TOLERANCES UNLESS OTHERWISE SPECIFIED: $\pm 0,05$.
PRINTED CIRCUIT BOARD THICKNESS: 1,6 mm NOMINAL.

BULK PACKAGED 1000pcs IN A BOX				4 POSITIONS/ 4 CONTACTS.				IN CONTACT AREA: 1,2µm MIN. SEL. GOLD OVER 1,2µm MIN. NICKEL				HOUSING: PTB,UL 94-HB COLOR: BLACK				216562-3							
TAPE MOUNTED 700pcs ON A 60cm DIA. REEL								SOLDER TINES: 2,0µm MIN. TIN-LEAD OVER 1,2µm MIN. NICKEL				CONTACTS: PHOSPHOR BRONZE				216562-1							
PACKAGING				REMARKS				FINISH				MATERIAL				PARTNUMBER							
												CUSTOMER DRAWING				FOR REFERENCE ONLY WILL NOT BE UPDATED							
												© COPYRIGHT 19 BY AMP HOLLAND B.V. ALL INTERNATIONAL RIGHTS RESERVED.AMP PRODUCTS MAY BE COVERED BY U.S. AND FOREIGN AND/OR PATENTS PENDING. THIS DRAWING IS UNPUBLISHED RELEASED FOR PUBLICATION				,19							
J SR10-0438-02				KV KV 08 OCT 02												Tyco Electronics Corporation Oostkamp - BELGIUM							
H1 0U60-0073-00				KV KV 10 AUG 00								NAME MODULAR JACK, 4 POS., TOP ENTRY, STANDARD SIZE, WITH PANEL STOPS FOR PRINTED CIRCUIT BOARD											
H EH00-1376-99				MVE MVE 22 JUL 99																			
G EH00-0939-99				JG ME APR 99																			
F EH00-0244-96				MVE GC 15 FEB 96																			
LTR. REVISION RECORD				DR. CHK. DATE																			
DR.: Lv.d.HEIJDEN				CHK.: C.STERKEN				APP.: Lv.SOEST				DWG.No.				REV.LTR.				SHEET			
DATE: 1 SEP 89				DATE:				DATE:				C-216562				J				1 OF 1			
																				A2			

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